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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chad A. Cobbley et al.

Serial No.: 10/770,941

Filed: February 03, 2004

For: STACKED DIE MODULE AND
TECHNIQUES FOR FORMING A
STACKED DIE MODULE

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Group Art Unit: 2813

Examiner: Blum, David S.

Atty Docket: MICS:0078—2 (FLE)
(01-0752.02)

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May 23, 2005	<i>Kerri Hyland</i>
Date	Kerri Hyland

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RESPONSE AND AMENDMENT

In response to the Final Official Action mailed on March 22, 2005, Applicants respectfully request reconsideration of the above-identified application in view of the amendments and remarks set forth below.